506578919 03/26/2021

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6625700

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

CONVEYING PARTY DATA

Name	Execution Date
MICHEL EVAN CHAUVIN	03/24/2021
ARNAUD MEYLAN	03/25/2021
BAO VINH NGUYEN	03/25/2021
PENG WU	03/26/2021

RECEIVING PARTY DATA

Name:	QUALCOMM INCORPORATED
Street Address: 5775 MOREHOUSE DRIVE	
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17211661

CORRESPONDENCE DATA

Fax Number: (310)201-5219

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 13102777200

Email: Qualcomm-USPTO@seyfarth.com

SEYFARTH SHAW LLP **Correspondent Name:**

2029 CENTURY PARK EAST, SUITE 3500 Address Line 1: Address Line 4: LOS ANGELES, CALIFORNIA 90067-3021

ATTORNEY DOCKET NUMBER:	206766
NAME OF SUBMITTER:	ALAN M. LENKIN
SIGNATURE:	/Alan M. Lenkin/
DATE SIGNED:	03/26/2021

Total Attachments: 6

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ASSIGNMENT

WHEREAS, WE,

- 1. Michel Evan CHAUVIN, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A.,
- 2. Arnaud MEYLAN, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A.,
- 3. Buo Vinh NGUYEN, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A.,
- 4. Peng WU, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A.,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to POWER OPTIMIZED UPLINK GRANT SKIPPING (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor, and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 17/211,661 filed March 24, 2021, Qualcomm Reference Number 206766, and all provisional applications relating thereto, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation

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applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States.

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty union organizations, and all divisional applications, renewal applications, continuation applications, continuation applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance:

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries:

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at,	<u>500 Jugo CA 05A</u> , on <u>N</u> City, State, Country	3/24/2021 Date	Michel Evan CHAUVIN	<u>autro</u> :
Done at	, on			
r. c. e.e.	City, State, Country	Date	Amaud MEYLAN	
Done at	, on			
	City, State, Country	Date	Bao Vinh NGUYEN	
Done at	, on			
	City, State, Country	Date	Peng WU	

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	City, State, Country	Date	Michel Evan CHAUVIN
Done at	Sam Diego, CA, on March City, State, Country	25 1/20. Date	2.1 ATAIL Com- Amaud MEYLAN
Done at	Oity, State, Country	Date	Bao Vink NGUYEN
Done at	, on City, State, Country	Date	Peng WU

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Qualcomm Reference Number: 206766
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AND WE HERFBY covenant that WF will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	, on		
***************************************	City, State, Country	Date	Michel Evan CHAUVIN
Done at	, on, City, State, Country	Date	Amaud MEYLAN
Done ar	Chy. State Country	<u>03/25/20</u> 2/ Date	Bao Vinh NGU YEN
Done at _	, on City, State, Country	Date	Peng WU

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AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at		, on		
	City, State, Country		Date	Michel Evan CHAUVIN
Done at		, on		
	City, State, Country	. «	Date	Amaud MEYLAN
Done at		, on		S. D. J. M. N. P. S.
	City, State, Country		Date	Bao Vinh NGUYEN
Done at	Shamphat, China. City, State, Country	, on <u>26.83.2</u>	のン} Date	Peng WU

PATENT REEL: 055746 FRAME: 0050

RECORDED: 03/26/2021